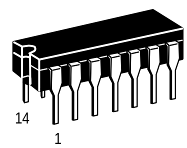
Phase-Frequency Detector

MC12040

PHASE–FREQUENCY DETECTOR

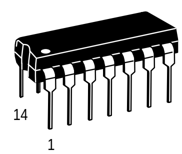
The MC12040 is a phase–frequency detector intended for use in systems requiring zero phase and frequency difference at lock. In combination with a voltage controlled oscillator (such as the MC1648, MC12147, MC12148 or MC12149), it is useful in a broad range of phase–locked loop applications. Operation of this device is identical to that of Phase Detector #1 of the MC4044. A discussion of the theory of operation and applications information is given on the MC4344/4044 data sheet.

- Operating Frequency = 80MHz Typical

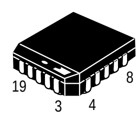


L SUFFIX
CERAMIC PACKAGE
CASE 632–08

Not Recommended for New Designs

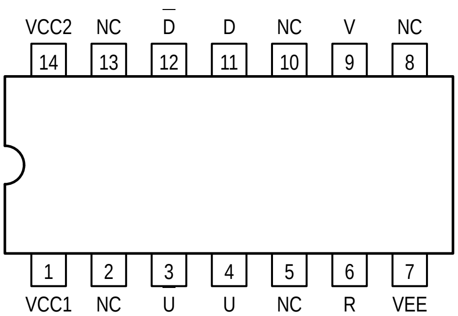


P SUFFIX
PLASTIC PACKAGE
CASE 646–06



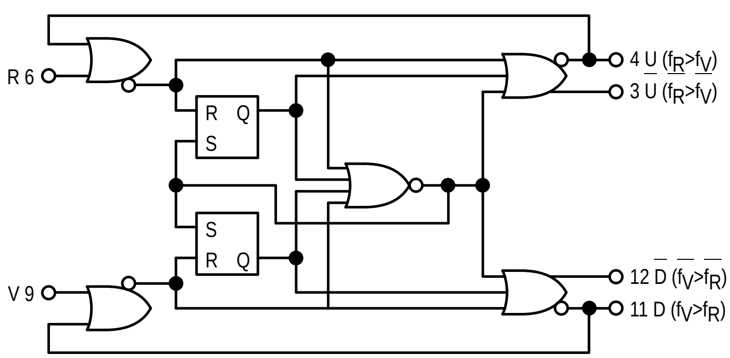
FN SUFFIX
PLCC PACKAGE
CASE 775–02

Pinout: 14–Lead Package (Top View)



NC = No Connect

LOGIC DIAGRAM



V_{CC1} = Pin 1
V_{CC2} = Pin 14
V_{EE} = Pin 7

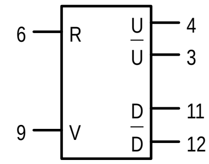
TRUTH TABLE
This is not strictly a functional truth table; i.e., it does not cover all possible modes of operation. However, it gives a sufficient number of tests to ensure that the device will function properly in all modes of operation.

Inputs		Outputs			
R	V	U	D	$\overline{U}$	$\overline{D}$
0	0	X	X	X	X
0	1	X	X	X	X
1	1	X	X	X	X
0	1	X	X	X	X
1	1	1	0	0	1
0	1	1	0	0	1
1	1	1	0	0	1
1	0	1	0	0	1
1	1	0	0	1	1
1	0	0	0	1	1
1	1	0	1	1	0
1	0	0	1	1	0
1	1	0	1	1	0
0	1	0	1	1	0
1	1	0	0	1	1

X = Don't Care

ELECTRICAL CHARACTERISTICS

The MC12040 has been designed to meet the dc specifications shown in the test table after thermal equilibrium has been established. Outputs are terminated through a 50 ohm resistor to +3.0V for +5.0V tests and through a 50 ohm resistor to –2.0V for –5.2V tests.



NOTE: For more information on using an ECL device in a +5V system, refer to Motorola Application Note AN1406/D, “Designing with PECL (ECL at +5.0V)”

TEST VOLTAGE VALUES (Volts)

@ Test Temperature	V_{IHmax}	V_{ILmin}	V_{IHAmin}	V_{ILAmax}	V_{EE}
0°C	–0.840	–1.870	–1.145	–1.490	–5.2
25°C	–0.810	–1.850	–1.105	–1.475	–5.2
75°C	–0.720	–1.830	–1.045	–1.450	–5.2

Supply Voltage = –5.2V

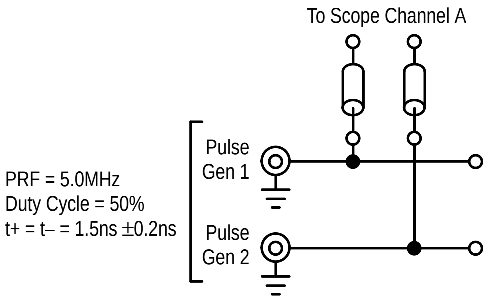
Symbol	Characteristics	Pin Under Test	MC12040 0°C Min	0°C Max	25°C Min	25°C Max	75°C Min	75°C Max	Unit	TEST VOLTAGE APPLIED TO PINS BELOW V_{IHmax}	V_{ILmin}	V_{IHAmin}	V_{ILAmax}	V_{EE}	(V_{CC}) Gnd
I_E	Power Supply Drain	7			–120	–60			mAdc					7	1,14
I_{INH}	Input Current	6 9				350 350			µAdc	6 9				7 7	1,14 1,14
V_{OH}[1]	Logic “1” Output Voltage	3 4 11 12	–1.000	–0.840	–0.960	–0.810	–0.900	–0.720	Vdc					7	1,14
V_{OL}[1]	Logic “0” Output Voltage	3 4 11 12	–1.870	–1.635	–1.850	–1.620	–1.830	–1.595	Vdc					7	1,14
V_{OHA}[2]	Logic “1” Input Voltage	3 4 11 12	–1.020		–0.980		–0.920		Vdc			6.9		7	1,14
V_{OLA}[2]	Logic “0” Input Voltage	3 4 11 12		–1.615		–1.600		–1.575	Vdc			9 6 9 6	6 9 6 9	7	1,14

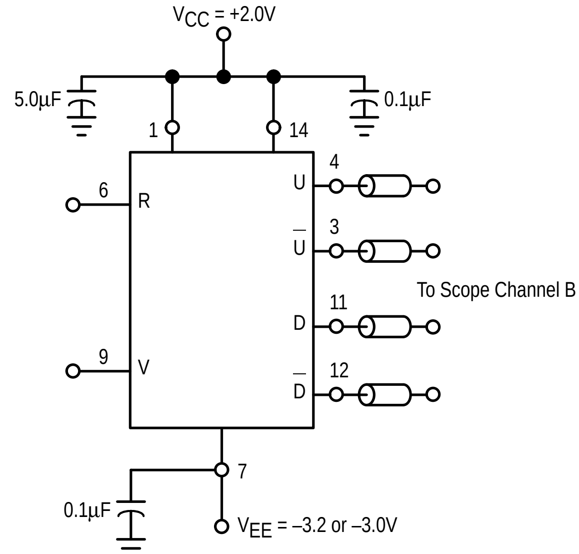
TEST VOLTAGE VALUES (Volts)

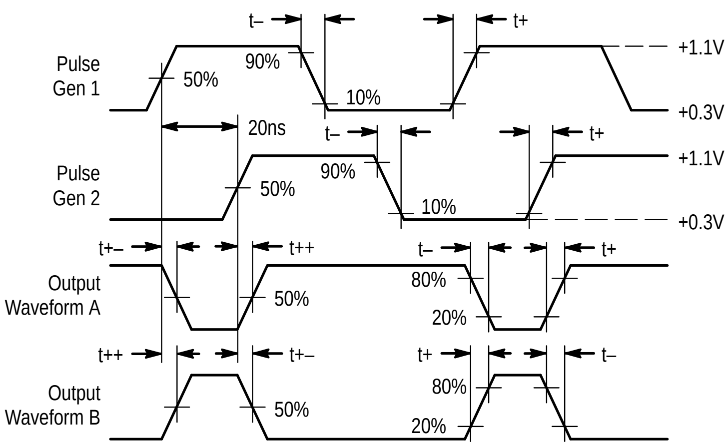
@ Test Temperature	V_{IHmax}	V_{ILmin}	V_{IHAmin}	V_{ILAmax}	V_{EE}
0°C	+4.160	+3.130	+3.855	+3.510	+5.0
25°C	+4.190	+3.150	+3.895	+3.525	+5.0
75°C	+4.280	+3.170	+3.955	+3.550	+5.0

Supply Voltage = +5.0V

Symbol	Characteristics	Pin Under Test	MC12040 0°C Min	0°C Max	25°C Min	25°C Max	75°C Min	75°C Max	Unit	TEST VOLTAGE APPLIED TO PINS BELOW V_{IHmax}	V_{ILmin}	V_{IHAmin}	V_{ILAmax}	V_{EE}	(V_{CC}) Gnd
I_E	Power Supply Drain	7			–115	–60			mAdc					1,14	7
I_{INH}	Input Current	6 9				350 350			µAdc	6 9				1,14 1,14	7 7
V_{OH}[1]	Logic “1” Output Voltage	3 4 11 12	4.000	4.160	4.040	4.190	4.100	4.280	Vdc					1,14	7
V_{OL}[1]	Logic “0” Output Voltage	3 4 11 12	3.190	3.430	3.210	3.440	3.230	3.470	Vdc					1,14	7
V_{OHA}[2]	Logic “1” Input Voltage	3 4 11 12	3.980		4.020		4.080		Vdc			6.9		1,14	7
V_{OLA}[2]	Logic “0” Input Voltage	3 4 11 12		3.450		3.460		3.490	Vdc			9 6 9 6	6 9 6 9	1,14	7







NOTES:

1. All input and output cables to the scope are equal lengths of 50Ω coaxial cable.
2. Unused input and outputs are connected to a 50Ω resistor to ground.
3. The device under test must be preconditioned before performing the ac tests. Preconditioning may be accomplished by applying pulse generator 1 for a minimum of two pulses prior to pulse generator 2. The device must be preconditioned again when inputs to pins 6 and 9 are interchanged. The same technique applies.

Figure 1. AC Tests

Symbol	Characteristic	Pin Under Test	Output Waveform	MC12040 0°C Max	MC12040 25°C Max	MC12040 85°C Max	Unit	Pulse Gen 1	Pulse Gen 2	V_{EE} –3.0 or –3.2V	V_{CC} +2.0V
t_{6+4+} t_{6+12+} t_{6+3-} t_{6+11-} t_{9+11+} t_{9+3+} t_{9+12-} t_{9+4-}	Propagation Delay	6,4 6,12 6,3 6,11 9,11 9,3 9,12 9,4	B A A B B A A B	4.6 6.0 4.5 6.4 4.6 6.0 4.5 6.4	4.6 6.0 4.5 6.4 4.6 6.0 4.5 6.4	5.0 6.6 4.9 7.0 5.0 6.6 4.9 7.0	ns	6 9 6 9 9 6 9 6	9 6 9 6 6 9 6 9	7	1,14
t_{3+} t_{4+} t_{11+} t_{14+}	Output Rise Time	3 4 11 14	A B B A	3.4	3.4	3.8	ns	6 6 9 9	9 9 6 6	7	1,14
t_{3-} t_{4-} t_{11-} t_{14-}	Output Fall Time	3 4 11 14	A B B A	3.4	3.4	3.8	ns	6 6 9 9	9 9 6 6	7	1,14

APPLICATIONS INFORMATION

The MC12040 is a logic network designed for use as a phase comparator for MECL–compatible input signals. It determines the "lead" or "lag" phase relationship and the time difference between the leading edges of the waveforms. Since these edges occur only once per cycle, the detector has a range of $\pm 2\pi$ radians.

Operation of the device may be illustrated by assuming two waveforms, R and V (Figure 2), of the same frequency but differing in phase. If the logic had established by past history that R was leading V, the U output of the detector (pin 4) would produce a positive pulse width equal to the phase difference and the D output (pin 11) would simply remain low.

On the other hand, it is also possible that V was leading R (Figure 2), giving rise to a positive pulse on the D output and a constant low level on the U output pin. Both outputs for the sample condition are valid since the determination of lead or lag is dependent on past edge crossing and initial conditions at start–up. A stable phase–locked loop will result from either condition.

Phase error information is contained in the output duty cycle–that is, the ratio of the output pulse width to total period. By integrating or low–pass filtering the outputs of the detector and shifting the level to accommodate ECL swings, usable analog information for the voltage controlled oscillator can be developed. A circuit useful for this function is shown in Figure 3.

Proper level shifting is accomplished by differentially driving the operational amplifier from the normally high outputs of the phase detector (U and D). Using this technique the quiescent differential voltage to the operational amplifier is zero (assuming matched "1" levels from the phase detector). The U and D outputs are then used to pass along phase information to the operational amplifier. Phase error summing is accomplished through resistors R1 connected to the inputs of the operational amplifier. Some R–C filtering imbedded within the input network (Figure 3) may be very beneficial since the very narrow correctional pulses of the MC12040 would not normally be integrated by the amplifier. General design guides for calculating R1, R2, and C are included in the MC4044 data sheet. Phase detector gain for this configuration is approximately 0.16 volts/radian.

System phase error stems from input offset voltage in the operational amplifier, mismatching of nominally equal resistors, and mismatching of phase detector "high" states between the outputs used for threshold setting and phase measuring. All these effects are reflected in the gain constant. For example, a 16mV offset voltage in the amplifier would cause an error of 0.016/ 0.16 = 0.1 radian or 5.7 degrees of error. Phase error can be trimmed to zero initially by trimming either input offset or one of the threshold resistors (R1 in Figure 3). Phase error over temperature depends on how much the offending parameters drift.

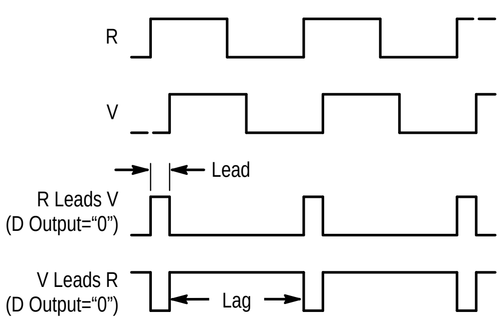


Figure 2. Timing Diagram

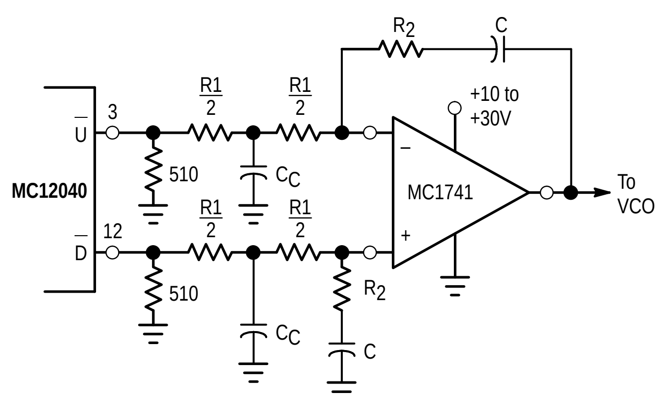
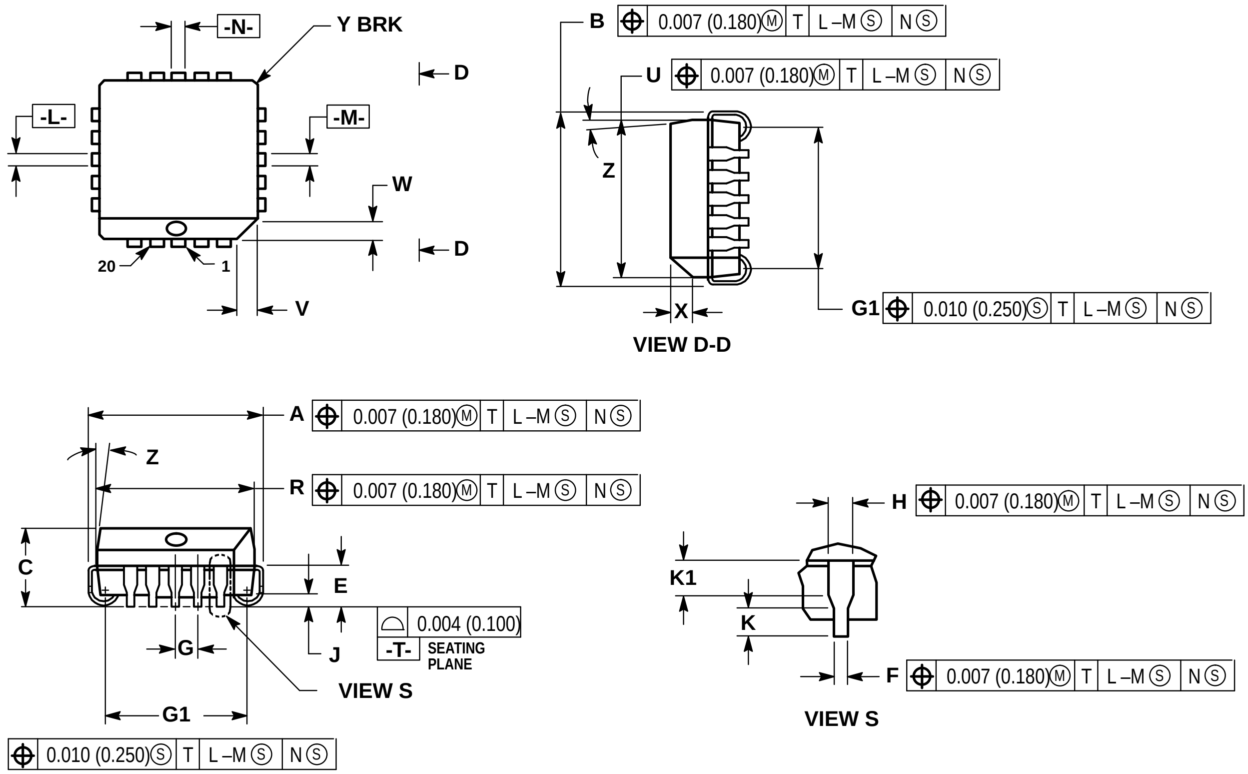


Figure 3. Typical Filter and Summing Network

OUTLINE DIMENSIONS

FN SUFFIX
PLASTIC PLCC PACKAGE
CASE 775–02
ISSUE C

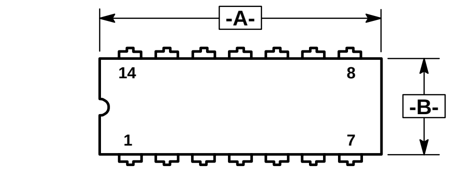


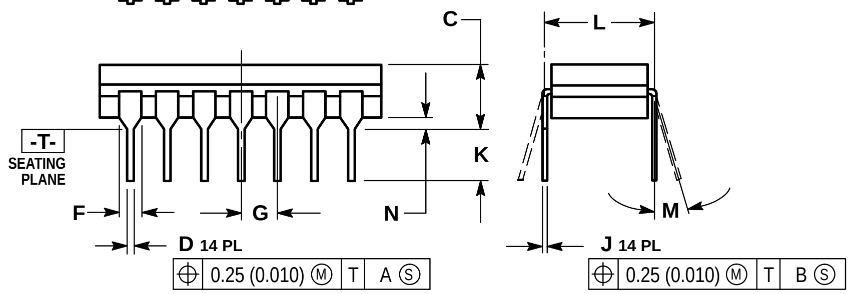
NOTES:
1. DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
2. DIM G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
3. DIM R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
4. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
5. CONTROLLING DIMENSION: INCH.
6. THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
7. DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.385	0.395	9.78	10.03
B	0.385	0.395	9.78	10.03
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	—	0.51	—
K	0.025	—	0.64	—
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	—	0.020	—	0.50
Z	2°	10°	2°	10°
G1	0.310	0.330	7.88	8.38
K1	0.040	—	1.02	—

OUTLINE DIMENSIONS

L SUFFIX
CERAMIC PACKAGE
CASE 632–08
ISSUE Y

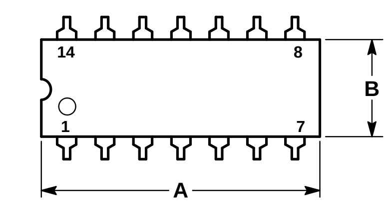


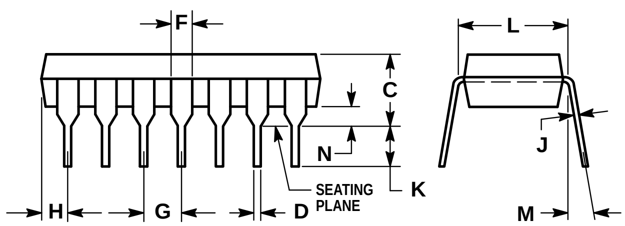


NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIMESNION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.94
B	0.245	0.280	6.23	7.11
C	0.155	0.200	3.94	5.08
D	0.015	0.020	0.39	0.50
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
J	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

P SUFFIX
PLASTIC PACKAGE
CASE 646–06
ISSUE L





NOTES:
1. LEADS WITHIN 0.13 (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.
2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
4. ROUNDED CORNERS OPTIONAL.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.715	0.770	18.16	19.56
B	0.240	0.260	6.10	6.60
C	0.145	0.185	3.69	4.69
D	0.015	0.021	0.38	0.53
F	0.040	0.070	1.02	1.78
G	0.100 BSC		2.54 BSC	
H	0.052	0.095	1.32	2.41
J	0.008	0.015	0.20	0.38
K	0.115	0.135	2.92	3.43
L	0.300 BSC		7.62 BSC	
M	0°	10°	0°	10°
N	0.015	0.039	0.39	1.01

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